

**SQ3000**+ Multi Function AOI, SPI & CMM

**Automated Optical Inspection** 



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# **Nordson TEST & INSPECTION**

Founded in 1954, Nordson Corporation is a market leading industrial technology company with annual revenues of over \$2.1 billion and more than 7,500 employees worldwide.

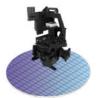
Nordson TEST & INSPECTION offers its SMT & Semiconductor customers a robust product portfolio, including Acoustic, Optical and both Manual and Automated X-ray Inspection systems, X-ray Component Counting systems and Semiconductor measurement sensors. Nordson TEST & INSPECTION is uniquely positioned to serve its customers with best-in-class precision technologies, passionate sales and support teams, global reach, and unmatched consultative applications expertise.





#### **Proprietary Advanced Technology**

Optical Inspection & Metrology







### WS Products

### **Improve Your** Yields

Semiconductor **Metrology Sensors** 





### AMI Products

### **Qualify Your** Design

Acoustic Inspection





### **BT** Products

### **Test Your** Design

**Bondtesters** 





### **AX** Products

#### **High Speed High Flexibility**

Automated X-ray Inspection

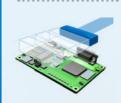




### MXI Products

### Making the Invisible, Visible

Manual X-ray Inspection

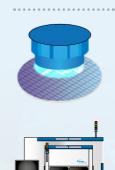




### **AXM** Products

#### **Measuring the** Invisible

Automated X-ray Metrology



### **CC** Products

### Maximize Efficiency

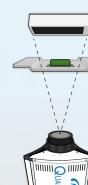
X-ray Component Counting



### XRT Products

### **High Speed High Resolution**

X-ray Technologies





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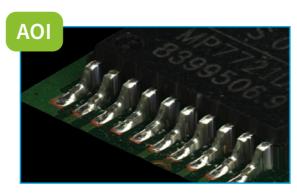
# **Multi Function Advantages**

SQ3000+ Multi-Function System with Multi-Reflection Suppression® (MRS®) sensor technology provides the ultimate combination of high resolution, high accuracy and high speed for inspection and metrology.



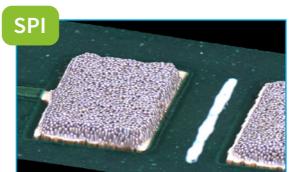
# AOI, SPI, CMM IN-LINE

The SQ3000+ remains the only system on the market capable of performing AOI, SPI and CMM in-line.



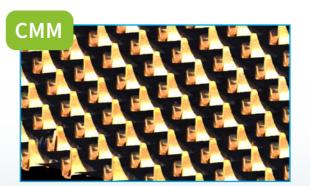
### **Automated Optical Inspection (AOI)**

The system is specifically designed for high-end applications including advanced packaging, mini-LED, advanced SMT, 008004/0201 SPI, socket metrology and other challenging CMM applications.



### **Solder Paste Inspection (SPI)**

The SQ3000+ offers unmatched accuracy with the revolutionary Multi-Reflection Suppression (MRS) technology by meticulously identifying and rejecting reflections caused by shiny components. Effective suppression of multiple reflections is critical for accurate measurement, making MRS an ideal technology solution for a wide range of applications including those with very high quality requirements.



### **Coordinate Measuring Machine (CMM)**

SQ3000+ utilizes CyberCMM™, a comprehensive software of coordinate measurement tools which provides highly accurate, 100% metrology-grade measurement on all critical points. A fast and easy setup can be performed with the world's first in-line CMM system for programming complex applications.

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# **Multi-Reflection Suppression®**

# (MRS®) Sensor Technology

The new, ultra-high resolution 5 micron MRS sensor incorporated into the SQ3000+ is specifically designed for advanced applications with the most demanding requirements.

#### **Reflection based distortions**

MRS is designed to Inhibit reflection-based distortions from shiny and specular surfaces Enabling the highest possible inspection accuracy at production speeds.

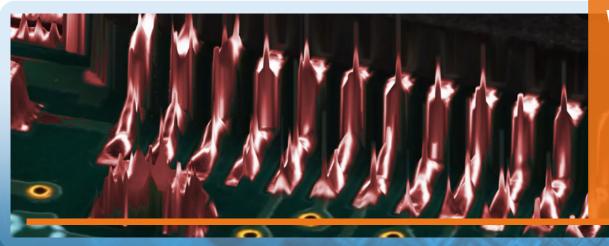
### **Unmatched accuracy**

SQ3000+ offers unmatched accuracy with the advanced MRS sensor technology by meticulously identifying and rejecting reflection-based distortions caused by shiny components and surfaces. Effective suppression of multiple reflections is critical for accurate measurements.

The new, ultra-high resolution 5 micron MRS sensor incorporated into the SQ3000+ is specifically designed for advanced applications with the most demanding requirements.



The SQ3000+ is powered by Nordsons' proprietary 3D sensing technology with sophisticated fusing algorithms that enables metrology grade accuracy at production speed. The result is ultra-high quality 3D images, high-speed inspection and metrology, and improved yields and processes.



Without MRS



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# **AOI Software**

The multi-award winning SQ3000 AOI software is a more powerful yet extremely simple software suite designed with an intuitive interface and multi-touch control with 3D image visualization tools.

### **Ultra-fast programming capabilities**

Bring the ease-of-use to a completely new level and significantly speeds setup, simplifies the process, reduces training efforts and minimizes operator interaction – all saving time and cost.

### **Enable smarter, faster inspection**

Speed programming and performance with AI<sup>2</sup> (Autonomous Image Interpretation) technology for set-up in <13 minutes with a data-rich, preloaded library and automated scripts that collect and update models all on their own.

Inspect the most comprehensive list of features and identify the widest variety of defects. Al<sup>2</sup> offers precise discrimination with just one panel inspection making it the perfect solution for highmix and high-volume applications.

#### $AI^2$

Al<sup>2</sup> technology is all about keeping it simple no parameters to adjust or algorithms to tune. And, you don't need to anticipate defects or pre-define variance either. Al2 does it all for you, powered by a data-rich, pre-loaded library and automated scripts that collect and update models all on their own.



With Al<sup>2</sup>, you have the power to inspect the most comprehensive list of features and identify the widest variety of defects. Al<sup>2</sup> offers precise discrimination with just one panel inspection making it a perfect solution for high-mix and high volume applications.

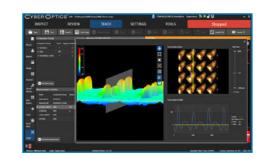






## **Powerful Add Ons**

Nordson Software Solutions provides our customers and partners the best added-value possible for inspection and measurement in electronics manufacturing.



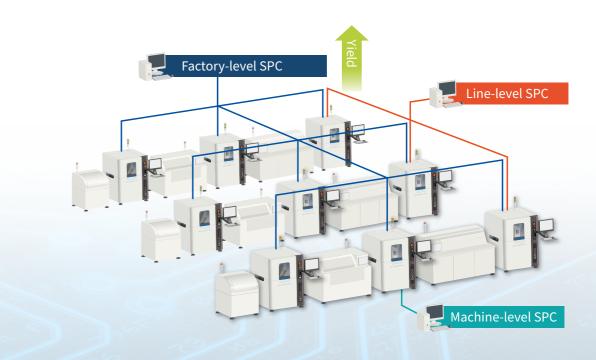
### **CyberCMM software suite**

CyberCMM™, a comprehensive software suite of coordinate measurement tools, provides highly accurate, 100% metrology-grade measurement on all critical points much faster than a traditional CMM, including coplanarity, distance, height and datum X, Y to name a few. A fast and easy set-up can be performed with the world's first in-line CMM system for programming complex applications as compared to slow, engineering resource-intensive set-up that typically requires multiple adjustments with traditional coordinate measurement machines (CMMs).

### Fast, scalable SPC solution

CyberReport™ offers full-fledged machine to factory level SPC capability with powerful historical analysis and reporting tools. The software delivers complete traceability for effective process verification and yield improvement.

CyberReport is designed for simple set-up and intuitive use, while simultaneously delivering scalability, fast charting, and an extremely compact database size.



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# **High End Applications**

The SQ3000+ is Nordson's Inspection and Metrology Solution for Assembly and Process Improvement. MRS technology is essential for high-end applications where quality and reliability are critical.





Fine pitch component inspection. BGA solder ball inspection, diameter measurement, uniformity. BGA coplanarity inspection.





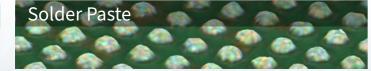
Backlight. Five point & solder paste inspection. Pad Gap inspection. Warpage corpenarity, Illumination Intensity & Adhesive Squeeze out measurements. Dye chip out.





Pin inspection, True position, Inspection on dispensed material, Inspecting dispensed patterns.

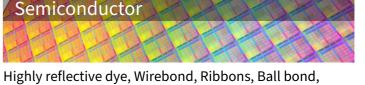




Tight area, Off water bridging, Speed and accuracy, Jet print paste, Type 4 paste.









Wirebonding and wedgebond inspection, Wirebond loop height of wire bond, Cornerfill/Underfill inspection.





Microelectronics, Fast and accurate inspection with low false calls, Fast programming, Speed and Accuracy, Quick programming.





Tighter tolerance, Higher demand for accuracy, Small components, More micro electronics, Conformal coating, Life Critical.





Component Verification, Counterfeit part detection, High map & Point cloud output capabilities, Adhesive & epoxy inspection.





Metal modules that have cavities, Suberate & Critical inspection on highly reflective material, Wire bond and ribbon inspection.





Tuning forks, connector, True position for key features, True position for key component for high precision placement, Smaller Modules, Critical pin inspection

# **Specifications**

Inspection Capabilities	5 Micron Ultra-High Resolution MRS Sensor
Inspection Speed	16 cm²/sec (2D+3D)
Minimum Component Size	0201 mm (008004 in.)
PCB Size	Minimum: 50 x 50 mm (2 x 2 in.); Maximum: 420 x 320 mm (16.5 x 12.5 in.)
Component Height Clearance	Top: 20 mm ; Bottom: 50 mm
PCB Thickness	0.1 - 5 mm
Component Types Inspected	Standard SMT (chips, J-lead, gull-wing, BGA, etc.), through-hole, odd-form, clips, connectors, header pins, and more
Component Defects	Missing, polarity, tombstone, billboard, flipped, wrong part, gross body and lead damage, and more
Solder Joint and Other Defects	Gold finger contamination, excess solder, insufficient solder, bridging, through-hole pins
3D Measurement Inspection	Lifted Lead, package coplanarity, polarity dimple and chamfer identification
Measurement Gage R&R	<10% @ ±3σ (±30 μm process tolerance)
Z Height Accuracy & Measurement Range	Z Height Accuracy: 0.5 μm on certification target • Z Height Measurement Range: 400 μm at spec, 2.4 mm capability

CMM Capabilities		
Accuracy & Resolution XY / Z	Accuracy XY / Z: 2 μm / 0.5 μm • Resolution XY / Z: 5 μm / 0.1 μm	
Maximum Weight	10 kg	
Min./ Max. Feature Height	Min. 10 μm ; Max. 400 μm at spec, 2.4 mm capability	
Maximum Feature Size	420 x 320 mm (16.5 x 12.5 in.)	
Carrier Thickness	0.1 - 5 mm	
Coordinate Measurement Capability	Line / Distance / X,Y / Mid Line, Inter Point / Regression Shifted, Datum X,Y / LSF X,Y Offset, X,Y Offset / Value / Location / List of X,Y Values, Height / Local Height / Regression / Radius, Coplanarity/ Distance to plane / 2nd Order fitting, Differ- ence / Absolute / 2sqrt / VC, Max / Min / Ave / Sigma / Plus / Minus / Multiple	

Vision System & Technology		
Imagers	Multi-3D sensors	
Resolution	5 μm	
Field of View (FOV)	25 x 25 mm	
Image Processing	Autonomous Image Interpretation (Al²) Technology, Coplanarity and Lead Measurement	
Programming Time	<13 minutes (for established libraries)	
CAD Import	Any column-separated text file with ref designator, XY, Angle, Part no info; Valor process preparation	
Field of View (FOV) Image Processing Programming Time	25 x 25 mm  25 x 25 mm  Autonomous Image Interpretation (AI²) Technology, Coplanarity and Lead Measurement  <13 minutes (for established libraries)	

System Specifications		
Machine Interface	SMEMA, RS232 and Ethernet	
Power Requirements	100-120 VAC or 220-240 VAC (±10%), 50/60 hz, 10-15 amps	
Compressed Air Requirements	5.6 Kgf/cm² to 7.0 Kgf/cm² (80 to 100 psi @ 4 cfm)	
System Dimensions	135 x 148 x 175 cm (W x D x H)	
Weight	2,350kg (5180 lbs.)	

Options	
	Barcode Reader, Rework station, CyberReport SPC Software, Alignment Target
	SQ3000™, SQ3000™ X (Large Board), SQ3000™ D (Dual Lane), and SQ3000™ DD (Dual Lane - Dual Sensor) models
	available

For more information, speak with your Nordson representative or contact your Nordson regional office

Nordson Test & Inspection Europe, SEA, Africa

ti-sales-eu@nordson.com

Nordson Test & Inspection Americas

ti-sales-us@nordson.com

**Nordson Test & Inspection China** 

ti-sales-cn@nordson.com

**Nordson Test & Inspection Japan** 

ti-sales-jp@nordson.com

**Nordson Test & Inspection Singapore** 

ti-sales-eu@nordson.com

**Nordson Test & Inspection Taiwan** 

ti-sales-tw@nordson.com

Nordson Test & Inspection Korea

ti-sales-korea@nordson.com





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